

**Information Letter Number:** 221001**Date:** 03.07.2022**Title:** Staking process added to SFM3400-33-D production.**Product Identification:**

1-101607-01: SFM3400-33-D

**Reason for Change:** Design Production Logistics Manufacturing Location Quality/Reliability Upgrade**Change Description:**

In Sensirion's effort to continuously improve their sensors, the mechanical stability of the SFM3400-33-D against torsion forces could be reinforced by adding a staking process to attach the PCB onto the housing. The interface, form, fit, function and performance of the sensor remain unchanged.

Sensirion offers our distributors a free upgrade of their current stocks to the new SFM3400-33-D version. The current stock does not need to be returned but can be discarded upon receipt of the upgraded sensors.

**Identification Method to Distinguish Change:**

Visible four staking points holding the PCB onto the housing.  
Serial number larger than 22120001

**Samples:** available will be available in not applicable**Quantifiable Impact on Quality & Reliability:**

Improved stability leads to higher reliability.

No negative impact as stacking process is already successfully used for SFM3400-33-AW.

**Estimated Implementation Date\*:** April 2022

\* The Estimated Implementation Date is the forecasted date that a customer may expect to receive changed product. This may be affected by fluctuations in supply and demand.

**Sensirion Contact:** [intl-sales@sensirion.com](mailto:intl-sales@sensirion.com)

If you have questions with regard to this Information Letter, please send them to the Sensirion contact e-mail address listed above.